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SHEET

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and the attached original document(s) or copy(ies) thereof.

1. Name of conveying party(ies):

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address of receiving party(ies):

- (1) Toshiyuki OGATA
(2) Kotaro ENDO
(3) Hiromitsu TSUJI
(4) Masaaki YOSHIDA
(5) Mitsuru SATO
(6) Syogo MATSUMARU
(7) Hideo HADA

Name: TOKYO OHKA KOGYO CO., LTD.Street Address: 150, Nakamaruko, Nakahara-ku, Kawasaki-shi, Kanagawa 211-0012 JapanAdditional name(s) & address(es) attached? NoAdditional name(s) of conveying party(ies) attached? No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
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Execution Date: October 5, 2005

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: October 5, 2005

A. Patent Application No.(s)
NEW, filed October 17, 2005B. Patent No.(s)
, issued

10/553315

Additional numbers attached?

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: WENDEROTH, LIND & PONACK, L.L.P.
Attn: Matthew M. Jacob, Esq.Street Address: 2033 K Street, N.W., Suite 800City: Washington, State: DC ZIP: 20006-10216. Total number of applications and patents involved: 17. Total fee (37 CFR 3.41). \$40.00☒ Enclosed (Check No. 70653)
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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Matthew M. Jacob, Reg. No. 25,154
Name of Person SigningMatthew M. Jacob
SignatureOctober 17, 2005
Date

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ATTACHMENT D

PATENT

REEL: 017878 FRAME: 0487

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Insert Name(s) of Inventor(s) Toshiyuki OGATA, Kotaro ENDO, Hiromitsu TSUJI, Masaaki YOSHIDA, Mitsuru SATO,
Syogo MATSUMARU and Hideo HADA
c/o TOKYO OHKA KOGYO CO., LTD., 150, Nakamaruko, Nakahara-ku, Kawasaki-shi, Kanagawa 211-0012

Insert Name(s) of Assignee(s) the undersigned hereby sell(s) and assign(s) to
TOKYO OHKA KOGYO CO., LTD.
 Address of 150 Nakamaruko, Nakahara-ku, Kawasaki-shi, Kanagawa 211-0012 Japan

Title of Invention (hereinafter designated as the Assignee) the entire right, title and interest for the
United States as defined in 35 USC 100, in the invention known as
PHOTORESIST COMPOSITION, AND LOW-MOLECULAR COMPOUND AND HIGH-
MOLECULAR COMPOUND FOR THE PHOTORESIST COMPOSITION

Date of Signing of Application for which an application for patent in the United States has been executed by the
undersigned
on Oct. 5, 2005

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, D.C. 20006-1021, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date: <u>Oct. 5, 2005</u>	<u>Toshiyuki Ogata</u> (Signature of Inventor) Toshiyuki OGATA
Date: <u>Oct. 5, 2005</u>	<u>Kotaro Endo</u> (Signature of Inventor) Kotaro ENDO
Date: <u>Oct. 5, 2005</u>	<u>Hiromitsu Tsuji</u> (Signature of Inventor) Hiromitsu TSUJI
Date: <u>Oct. 5, 2005</u>	<u>Masaaki Yoshida</u> (Signature of Inventor) Masaaki YOSHIDA
Date: <u>Oct. 5, 2005</u>	<u>Mitsuru Sato</u> (Signature of Inventor) Mitsuru SATO
Date: <u>Oct. 5, 2005</u>	<u>Shogo Matsumaru</u> (Signature of Inventor) Syogo MATSUMARU
Date: <u>Oct. 5, 2005</u>	<u>Hideo Hada</u> (Signature of Inventor) Hideo HADA

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness <u>Makoto Miwa</u>	Makoto MIWA
Witness <u>Osamu Kato</u>	Osamu KATO

ACKNOWLEDGMENT

_____) ss

This _____ day of _____, 20____, before me personally came the above-named me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth.

SEAL

Official Signature

Official Title

The above application may be more particularly identified as follows:

U.S. Application Serial No. _____ Filing Date _____

Applicant Reference Number _____ Atty Docket No. _____

TITLE OF INVENTION

PHOTORESIST COMPOSITION, AND LOW-MOLECULAR COMPOUND AND HIGH-MOLECULAR COMPOUND
FOR THE PHOTORESIST COMPOSITION